



Product Change Notification

113829 - 01

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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

Americas Contact: asmo.pcn@intel.com

Asia Pacific/PRC Contact: apacgccb@intel.com

Europe Email: eccb@intel.com

Japan Email: jccb.ijkk@intel.com

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Product Change Notification

Change Notification #: 113829 - 01
Change Title: Intel® RAID Maintenance Free Backup Unit
AXXRMFBU2
PCN 113829-01, Transport Media
Update the Outer Box Packaging
Reason for Revision: Revised for posting to public QDMS
Date of Publication: June 9, 2015

Key Characteristics of the Change:

Transport Media

Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material*:	May 19, 2015
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** Intel appreciates the customer's desire to receive the latest revision of products. However, Intel manages inventory on a first in first out (FIFO) basis at the MM# level. Subsequently, customer requests for a specific revision of material (below the MM#) will not be supported by Intel.*

Description of Change to the Customer:

Reason for Revision: Revised for posting to public QDMS

Intel is implementing the following changes on the outer box for the Intel® RAID Maintenance Free Backup Unit AXXRMFBU2 to meet the new Intel package standards and procedures:

1. Add the International Standard ISO 780 symbols including No.1 “FRAGILE”, No.3 “THIS WAY UP”, and No.6 “KEEP AWAY FROM RAIN”.



2. Update the required recycling symbols including the Internationally Recognized Recycling symbol for paper and the FIBRE ASSOCIATION (FBA) “Corrugated Recycles” symbol.



3. Remove the UL logo and printed statement of “To save the earth 100% of the package material used is recyclable”.

Customer Impact of Change and Recommended Action:

Intel anticipates no impact to customers, but encourages customers to understand the changes and determine the impact on their applications.

Products Affected / Intel Ordering Codes:

Product Code	MM#	Pre Change TA	Pre Change PBA	Post Change TA	Post Change PBA
AXXRMFBU2	926341	G46229-303	G50073-303	G46229-304	G50073-303

PCN Revision History:**Date of Revision:**

May 4, 2015

June 9, 2015

Revision Number:

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Reason:

Originally Published PCN

Revised for posting to public
QDMS